

12500 TI Boulevard, MS 8640, Dallas, Texas 75243

PCN# 20080729000 Datasheet Errata for Device SN74AS374 Information Only

Dear Customer:

This is an information-only announcement of a change to a device that is currently offered by Texas Instruments.

The changes discussed within this PCN are for your information only. Please see the attachment details for the planned implementation date.

This notification period is per TI's standard process. Any negotiated alternative change requirements will be provided via the customer's defined process. Customers with previously negotiated, special requirements will be handled separately. Any inquiries should be directed to your local Field Sales Representative.

For questions regarding this notice, contact your local Field Sales Representative or the PCN Manager (PCN www admin team@list.ti.com).

Sincerely,

PCN Team SC Business Services Phone: +1(214) 480-6037 Fax: +1(214) 480-6659

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|---|---------------------------------------|-------------|----------------------|--------------|----------------------|----------------|---------------------|--------------------|---------------|------------|
| PCN Number : 20080729000 | | | | | | | Date: | 08/05/20 | 800 | |
| Title: Datasheet Errata for Device SN74AS374 | | | | | | | | | | |
| Customer Contact: Linda K Miles Phone: 903-868-7638 Dept: Standard Linear and Logic | | | | | | | | | | |
| Proposed 1st Sh | nip Date | e: N/A | | Estima | ated Sa | ample | e Availa | bility: | N/A | |
| Change Type: | | | | | | | | | | |
| Assembly Site Ass | | | embly Process | | | | Asser | Assembly Materials | | |
| ☐ Design ☐ Ele | | ctrical Spe | n Mechar | | | anical Sp | nical Specification | | | |
| Test Site | | Pac | Packing/Shipping/Lak | | | | | Test Process | | |
| Wafer Bump Site | | ☐ Wa | Wafer Bump Material | | | | Wafe | r Bump P | rocess | |
| Wafer Fab Site | | Wa | Wafer Fab Materials | | | | Wafei | Wafer Fab Process | | |
| PCN Details | | | | | | | | | | |
| Description of Change: | | | | | | | | | | |
| Texas Instruments Standard Linear and Logic will be changing the minimum value for TPHL from 4.0nS to | | | | | | | | | | |
| | | | | | | | | | | |
| 3.7nS. Below please find an extract of the table from page 5 of the current data sheet. | | | | | | | | | | |
| Change From: | | | | | | | | | | |
| | T | | T | | ı | | T | | 1 | İ |
| PARAMETER | FROM | и то | | | | AS374 | | 4AS374 | UNIT | Ì |
| T A GO WILL I LIX | (INPUT | ·) | (OUTPUT) |) | MIN | MAX | | MAX | 01111 | Ì |
| TPHL | CLK | | Q | | 4 | 11.5 | 4 | 9 | ns | İ |
| Change To: | | | | | | | | | | |
| PARAMETER FROM (INPUT | | TO (OUTPUT) | | | SN54AS374 MIN MAX | | SN7 | 4AS374 | AS374 MAX | |
| | | | |) | | | | | | |
| TPHL | CLK | / | Q | <u> </u> | 4 | 11.5 | | 9 | ns | Ì |
| TILE | | | | | | | | | | |
| Literature Number | | | | | | | | | | |
| Device Type | | | | | | _ | New Literature # | | | |
| SN74AS374 | | | SDAS167C S | | | SDAS | SDAS167D | | | |
| Reason for Cha | nge: | | | | | | | | | |
| This change will | correct | the datash | neet. | | | | | | | |
| Anticipated imp | oact on | Fit, Forn | n, Functio | on, Qua | lity or | Relia | bility (p | ositive | / negativ | 'e): |
| Texas Instrumen | ts does | not antici | pate an im | npact on | fit, for | m, fui | nction, q | uality no | r reliability | y . |
| Changes to pro | duct id | lentificati | on result | ing fro | n this | PCN: | | | | |
| There is no chan | ge to pr | oduct ider | ntification. | | | | | | | |
| Product Affecte | ed: | | | | | | | | | |
| SN74AS374DW SN74AS374 | | 4DWRG4 SN | | 174AS374NS | | | SN74AS374NSRE4 | | | |
| SN74AS374DWG4 SN74AS374 | | | 74AS374NSE4 | | | SN74AS374NSRG4 | | | | |
| SN74AS374DWR SN74AS374NE4 | | | SN74AS374NSG4 | | | | | | | |
| SN74AS374DWRE4 SN74AS374N-J | | | | SN74AS374NSR | | | | | | |

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

| Location | E-Mail |
|--------------|--------------------------------|
| USA | PCNAmericasContact@list.ti.com |
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